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Capable of GaN based micro-light emitting diodes operated at the injection level of kA/cm²

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Abstract: Electrical and optical properties of different size InGaN/GaN micro-LEDs (μLEDs) are investigated in high injection level. Electroluminescence (EL) results show that 10 μm diameter LED can be well operated under current density above 16 kA/cm², while the 300 μm one can only endure 226 A/cm². Streak camera time resolved photoluminescence (TRPL) results show obviously that the decay rate is much faster for smaller size μLED because of less band-gap renormalization (BGR). Combining with APSYS simulation, the high injection level carriers transportation and recombination mechanisms are investigated in terms of current spreading, BGR and strain relaxation.

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1. Introduction

Although the luminous efficiency have been achieved more than 300 lm/W, the efficiency droops appear disappointedly in the most excellent light emitting diodes (LEDs) under high injection level or high temperature [1,2]. By now few conventional LEDs can work for current densities in the order of hundreds of A/cm$^2$. The origins of the efficiency droop can be roughly divided into three categories, including internal nonradiative losses, electron leakage and junction temperature [3]. Many remedies have been reported, such as double heterostructure (DH) active layer [4], polarization matched barriers and electron blocking layer [5, 6], nonpolar LED [7], GaN homogeneous epitaxy on freestanding substrate [8], improved hole injection [9], and so on. Some researchers have been achieved the current density more than 500 A/cm$^2$ for nanorod LEDs with low efficiency droop [10]. The high cost nano-processing, point defects and self-heating may hinder these LEDs to practical application.

Recently, much attention has been paid to the specific small chip size, tens micron LEDs ($\mu$LEDs), which can effectively reduce droop phenomenon, even endure high current density of several kA/cm$^2$ [11-17]. More uniform current spreading for smaller size LED has been found by some groups [13, 15, 17]. The efficiency droop will be alleviated for tens micron LED since the current spreading length is more than 50 $\mu$m for the general LED epi-structures [15, 18]. On the other hand, the junction temperature (Tj) is also decreased when the size of LED is reduced because of the thermal dissipation and uniform current spreading [2, 13, 16-17]. Generally, current spreading and Tj distribution seem to be the main factors for high current endurance of $\mu$LEDs. Low Tj may improve the luminous efficiency of $\mu$LED, but not well affect the high injection performance [2]. Even if the conventional broad LEDs are driven by high low-duty pulsed current, they cannot endure one order higher current density. However, the maximum endured current density is still increased as the size of $\mu$LEDs reducing down below the current spreading length. There are few considerations beyond the current spreading and Tj.

It is noted that certain amount injected carriers are extracted by the drift field in p-type electron barrier layer and p-GaN quasi-neutral region [19], the concentration of the trapped carriers in QWs could reach $10^{19}$ cm$^{-3}$ with the current density above several hundred A/cm$^2$. Band-gap renormalization (BGR) and band-filling will be happened when the carrier concentration is more than mid $10^{18}$ cm$^{-3}$ [20-22]. Kim et al found that the BGR effect was strengthened with an increase of the biaxial compressive strain [23]. What is more important, the BGR can build an additional potential barrier for carriers to inhibit their transferring from high-to-low energy state, thus leading to efficiency saturation [24]. Band-filling model including localized state, extended state and mobility edge has been also used to investigate the recombination processes under high injection level [21, 25-26]. The above theories may be useful for understanding the high injection performance of smaller $\mu$LEDs.

In this work, the different size $\mu$LEDs were fabricated using a compatible process with the conventional LED. The electroluminescence (EL) spectra were measured on the different size $\mu$LEDs. The remarkable performances under the injection level of kA/cm$^2$ were achieved for small size $\mu$LEDs. Current distributions along the mesa of $\mu$LEDs were obtained with the simulations by the APSYS software package. The carrier dynamic recombination process for $\mu$LEDs was investigated by the time-resolved photoluminescence (TRPL) measurements under high excitation power.

2. Experiments:

The $\mu$LED structure grown by metal organic chemical vapor deposition (MOCVD) was comprised of a nucleation layer on the sapphire substrate, a 2 $\mu$m undoped-GaN layer, a 2.5 $\mu$m n-GaN layer, a ten-period InGaN(2.2 nm)/GaN(15 nm) multiple quantum well (MQW) with the emission wavelength at about 460 nm, and a 230 nm-thick p-GaN layer. The sizes of
active regions were defined from 300 to 10 μm by conventional photolithography and inductively coupled plasma (ICP) etching. The other detailed fabrication procedures for EL sample can be found in our previous work [13, 14]. The platform of 8×8 μLEDs chip array is shown in Fig.1a. The array has a pitch of 1 mm. The diameters of μLED pillars for each row are same, while those for different rows downward are decreased in sequence from 300 to 10 μm. The p-pad squares are connected with the μLED pillars by metals.

The light output power (LOP) measurements were performed by a calibrated Si photo-detector while the EL spectra were collected by SSP 6612 LED Multiple Parameters Tester with a coupled spectrometer and charge coupled device (CCD) detection system in an integrated sphere. The pulse current was gradually applied on these μLEDs with the current densities from 0 to 16 kA/cm². The pulse width is 10 microsecond, and the duty cycle is 0.1%. The source power would turn off to protect the devices until the peak wavelength red shift and the light output was saturated for each μLED.

The time-resolved photoluminescence (TRPL) measures were performed using a Ti:sapphire laser. The μLED samples prepared for TRPL were divided to different size regions, in which region the same size μLEDs were arrayed in a 5 mm length square area. The pulse of the laser was centered at 800 nm with the width of 34 fs, and the repetition rate was 1 kHz. The incident wavelength of doubled-frequency laser was 400 nm. The laser beam diameter is about 1 mm². The streak camera (c10910 series) was used to collect signal, with 1ps temporal resolution, test wavelength range from 421 to 525.5 nm. The pump laser penetrated into μLEDs array to produce fluorescence which is focused into streak camera. Then, these photons were converted to electrons with a distribution related to the decay time. The electrons generated at different time would be accelerated to take different energy. The electrons passing through deflecting electric field would have different deflecting distance, and then hit the phosphor plate in different position according to the decay time.

The current distribution of μLEDs were investigated numerically by APSYS package of Crosslight software, which solves the Poisson equation, current continuity equations, photon rate equation, and scalar wave equation with the current spreading, strain relaxation and thermal effect being taken into account. The typical structure of μLED is shown schematically in Fig.1b. The LED structure is similar to the experimental one, including 100 μm sapphire substrate. The carrier concentration of n-doped GaN layer is $5 \times 10^{18}$ cm⁻³, and $8 \times 10^{17}$ cm⁻³ for p-doped GaN. The diameters of μLED pillars were assigned with 300, 160, 80, 40 and 10 μm.
3. Results and analysis

Fig.2. The dependencies of light output power (LOP) on the current density (L-I) for 10, 20, 40, 80, 160 and 300 μm LEDs.

Fig.2 shows the dependencies of light output power (LOP) on the current density (L-I) for μLEDs with different diameters. The L-I curves show that the small size μLEDs can endure high current density. 10 μm LED is survived at extremely high current density of 16 kA/cm². The LOP seems not saturate at so high injection level, while that of 300μm LED is saturated at the current density of 226 A/cm². The endurable current densities for μLEDs are higher than ones in our previous work [13] because the most surrounding area with p-type GaN mesa is covered with n-contact metal. The LOP of 10μm LED is 3.5 times as that of 300μm LED at 200 A/cm². The efficiency improvement under high injection level for small size μLED may be attributed to low Tj and uniform current spreading [13]. However, low Tj may improve the luminous efficiency of μLED, but not well affect the efficiency droop [2]. The following simulations about current distribution show that the tens micron LEDs have uniform current distributions. The other factors should be considered to the extremely high current density for smaller size μLEDs.

Fig.3. EL spectra measured under different current densities (a) from 0.2 to 282.9A/cm² for 300μm LED and (b) from 6.4 to 1273.2A/cm² for 10μm LED. (c)The simulated current density distributions along the mesa diameter neighbor to the last QW of μLEDs with different sizes. The average current density is 200 A/cm².

The EL spectra under different current densities are shown in Fig.3 for 300 and 10 μm LEDs. It seems that not only the transportation properties are changed when the size of μLED is reduced, and the recombination processes should be concerned under high injection level. Under low injection level, the peak wavelengths blue shift for both of the two LEDs. The shapes and widths of the EL spectra are little changed. When the current density is more than a critical point, the spectra are broadened. The critical points are 56.6 and 318.3 A/cm² for 300 and 10 μm LEDs, respectively. The red shift can be observed for 300 μm LED, while no red shift can be observed for 10μm LED in Fig.3b. Carrier screening and band filling are usually supposed as the causes for the blue shift of the emission from MQWs with the current...
density increasing. The carrier concentration is below $10^{19}$ cm$^{-3}$ in QW when the injection level is about 200 A/cm$^2$ simulated by APSYS soft package for the above LEDs. This carrier concentration is not enough for band filling since the QW is undoped InGaN layer [21]. So the blue shift in this injection region is mainly due to the carrier screen of the polarization field. When the injection level increases to the order of kA/cm$^2$, the carrier concentration is above several $10^{19}$ cm$^{-3}$ in QW. The screening effect may be completed when the concentration is above several $10^{19}$ cm$^{-3}$ [20]. The blue shift may be attributed to band filling effect.

On the other hand, the lateral current distribution should be considered in the MQWs. Fig. 3c shows current density distributions in p-GaN layer neighbor to the last QW, where the average ones are 200 A/cm$^2$ for all the µLEDs. Relative position is equal to the ratio of the distance between the left edge and test point to the diameter of µLED. It is clearly that the current density at the sidewall is more than that in the center of the pillar for all µLEDs. The maximum is about 1200 A/cm$^2$ at the sidewall for 300 µm LED, which is 16 times of that in the center. The maximum is about 240 A/cm$^2$ at the sidewall for 10 µm LED, while the minimum is 180 A/cm$^2$ in the center. The current spreading is more uniform for 10 µm LED than 300 µm LED. With the current density increases, the current inhomogeneity would become serious [27]. It is reasonable that the spectrum will be broadened in case of the current crowding because the local carrier concentration determines the emission wavelength. When the current density exceeds the critical point, the spectra are broadened as shown in Fig. 3a and 3b. The redshift is simultaneously happened for 300 µm LED. Self-heating and BGR effects may lead to the red shift with the current density increasing. Due to the pulse current is adopted, self-heating can be avoided. So the significant redshift for 300 µm LED above 127.3 A/cm$^2$ is mainly due to BGR effect. The current densities crowded at the sidewall are more than 1 kA/cm$^2$. However, the red shift cannot be observed for 10 µm LED even the average current density is more than 1 kA/cm$^2$. The effect of size on BGR effect will be discussed later.

![Fig. 4. Temporal and spectroscopic profile probed by the streak camera for µLEDs with different sizes: (a) 300µm, (b) 80µm, (c) 10µm. The excitation power of the laser is 4mW.](image)

In the streak camera TRPL experiment, the excitation wavelength is 400 nm (3.1 eV). The energy of a single pulse is 4 µJ, and the laser spot size is about 1mm. The PL signals are the integral intensities of µLEDs array with the same diameter in 1mm area. The band energy gap of InGaN QW is 2.69 eV (460 nm), the total width of ten QWs is about 22.0 nm. The absorption coefficient $\alpha$ is about $10^5$ cm$^{-1}$ at the excitation wavelength of 400 nm for InGaN QWs. So the single pulse energy absorbed by multiple QWs is about 0.80 µJ, corresponding to $5\times10^{12}$ eV. These photons excite InGaN QWs to generate about $1.6\times10^{12}$ pairs of electron and hole. The carrier density in a single QW is about $7.3\times10^{19}$ cm$^{-3}$. Considering the quantum efficiency for photogenerated carriers, the carrier density for TRPL measurement is close to the carrier density of EL under current density 1 kA/cm$^2$. Both of them belong to high
injection level. Fig.4 shows triangular profiles within 2 ns in streak camera images of 300, 80, and 10 μm LEDs. The decay rate of PL intensity of μLED obviously increases with the pillar size decreasing, and 10 μm LEDs show the most rapid decay rate.

![Image](image_url)

Fig.5. Temporal changes of PL spectra of (a) 300 μm and (b) 10 μm LEDs from 8 ps to 1.3 ns. The peaks are connected by short dash lines.

Fig.5 shows the temporal changes of PL spectra of 300 and 10 μm LEDs, which are drawn from Fig.4a and 4c. In the initial stage, the carriers are injected into the QWs, but the light emission is weak within about 100 ps. Before 70 ps, the spectra width is broad. Then the width is reduced to minimum before 140 ps, and keeps constant till 2 ns. Due to the energy difference of 0.41 eV between the excitation photons and InGaN band gap, the photogenerated carriers will have the excessive energy. Since the effective mass of hole is much larger than that of electron, the excessive energy are calculated as 86 and 316 meV for hole and electron [22], respectively. The depths of the MQWs are about 420 meV, so the electrons will be bounded in MQWs and exist as hot carriers. The initial dark time may be due to the hot carrier relaxation, because when the carrier concentration increases to more than $10^{19}$ cm$^{-3}$ in QWs, the relaxed time of hot carrier will be extended by two orders compared to the low carrier concentration bulk one [28]. If the hot carriers are not relaxed enough to the conduction band (CB) bottom and occupying the localization states, the carrier irraddiative recombination rate will be not high. In the relaxation process of hot electrons, electron-LO phonon scattering and electron-electron collisions could be occur [22], they would lead to a broadened spectra in low energy sides and a high-energy tail. The more emissions are located at the low energy side due to the LO phonon assistance. As time goes
on, the hot carrier concentration decreases, which will lead to blueshift and narrowing of the spectra. After 140 ps, most of the hot carriers may be relaxed, and the spectral widths become constant. Because the high carrier concentration is above $10^{19}$ cm$^{-3}$ which would induce the screening effect and BGR, the specific recombination mechanism will be further explored.

![Graphs showing time resolved peak intensities and peak wavelengths of PL spectra](image)

**Fig.6.** Time resolved (a) peak intensities (b) peak wavelengths of PL spectra are taken from the streak camera images for 300, 160, 80, 40, 10 μm LEDs with the time scale of 2 ns, and (c) peak wavelengths of PL spectra with the time scale of 50 ns for 300, 160, 80, 40, 10 μm LEDs.

Time resolved peak intensities and peak wavelengths of PL spectra are taken from the streak camera images for 300, 160, 80, 40 and 10 μm LEDs, as shown in Fig.6. The time resolved peak intensities curves in Fig.6a include a rising edge and a falling edge. The rising edges are terminated at about 140 ps, the slope of the rising edge increases with the size of μLED decreasing. Correspondingly, the decay rate also increases with the size of μLED decreasing in the residual time of 2 ns. The exception is the falling edge for 10μm LED, in which the initial decay rate is slower than those of the other larger size μLEDs, while the global falling edge decays most rapidly in the time of 2 ns. In Fig.6b, the time resolved peak
wavelengths show blue shift first, and then nearly constant for μLEDs within 2ns, the turning points are marked by circles. It is obviously that the blue shift is smaller for smaller size μLEDs, and less shift time as well. But the blue shift of 10 μm LED takes longer time, also as shown in Fig.5b. The time of 2 ns is too short to show the whole dynamics process of the photogenerated carriers. Fig.6c shows the peak wavelength change within 50 ns scale. The peak wavelengths blue shift first before 3.6 ns, and then keep constant for a while, and red-shift eventually. More clearly, there are trenches at about 3.2 ns for all the μLEDs. By expanding the time scale in the test, it is found that the blue shift is prolonged. Because the data are collected under different deflecting voltage in each time scale, the instrument response will be varied at different time scales. The measured data F(t) are the convolution of instrument response function (IRF(t)) and real data I(t), where t represents time. It is found that the counts peaks are usually appeared in the initial 5-8% of the time scale. The spectra evolution seems prolonged at the initial stage with the time scale increasing. After 5-8% of the time scale, the data is influenced weakly by instrument response for all time scales. Although the convolution affects the determination of the accurate time of carrier dynamics, its process can be observed by the spectra evolution. In a way the evolution with IRF would provide the time magnification of carrier dynamics, as shown in Fig.6c. It is advantageous to get more useful information. For example, the trenches are not clear as a brief process at small time scale while highlighted at larger one.

In order to explain the above results, a model of carrier dynamics is developed referring to Ref. [26], as shown in Fig.7. The model includes a schematic band diagram and possible paths of carrier transportation and recombination in InGaN QW in TRPL measurements. When the laser pulse illuminates the MQWs of μLEDs, photogenerated electrons with excess energy become hot carriers in the QWs. The localized states are almost empty at this time. As mentioned above, electron-phonon and electron-electron scattering lead to carrier relaxation to the states on CB bottom as free carriers. And then free carriers on CB bottom will relax to the localized states. At the initial time, the carrier concentrations both in CB bottom and localized states are low, and the recombination at these positions is weak. This is why the initial PL intensities are weak. Electron-electron, electron-LO phonon interactions in hot carriers cause the broad spectra and more emission at low energy side. As the hot carriers concentration decreases, phonon assisted recombination is weakened, and the peak wavelengths of spectra blue shift, which is shown in Fig. 6b and Fig. 6c. Due to the presence of free carriers in QWs, BGR happens at this moment, which will hinder carriers relaxation to low energy level. The compressive strain can enhance the BGR effect in InGaN QWs [23]. The strain will be relaxed when the size of μLEDs decreases, especially for 10μm LEDs. Thus the small size μLEDs have more free carriers relaxed to the localized states, and the long wavelength emissions begin playing roles, which lead to the small blue shift in the early stage in Fig. 6b and Fig.6c. As the hot carriers concentration decreases more, the concentration of free carriers balances with the localized carriers for a while for small size μLEDs. So the peak wavelengths of spectra keep constant. When the hot carriers are fully relaxed, the concentration of free carriers begins to decrease. Then BGR is distinctly weakened as the free carriers decrease, which will lead to the peak wavelength blue shift. Less BGR effects cause the localized states filled rapidly, which will lead to the peak wavelength redshift. Those changes of peak wavelengths like trenches, as shown in Fig. 6c. The PL intensities increase sharply when the localized states are occupied rapidly. Due to the less BGR, the transition to localized states is more rapid for smaller size μLEDs [24]. So the slope of the rising edge increases with the size of μLED decreasing in Fig.6a. The PL intensities approach their maxima when the sum of the radiative recombination rate for the localized and free carriers on the CB bottom is largest. These recombination components make the initial part fall rapidly after the peak intensity. Because the small size μLEDs have a faster recombination rate for weaker BGR effect, the initial part of the failing edge drops more rapidly. When the free carriers concentration is reduced further, they would relax to the
localized states rather than recombine with other carriers. Then, recombination of localized states plays a dominant role. So the decay rate is reduced to a constant in the residual time of 2 ns. In Fig.6a, the 10 μm LED doesn’t have the initial part with rapid rate at the failing edge. It should be due to the weakest BGR effect in 10 μm LED. The free carriers will not crowd in CB bottom, and likely relax to localized state. It is also the reason why the blue shift of peak wavelength prolongs for 10 μm LEDs in Fig.6b. At last, when the free carriers are also depleted, the redshift will be happened since the carriers in shallow localized states is recombined more rapidly than those in deep ones, as shown in Fig. 6c.

\[\text{Fig.7. Energy band diagram of conduction band for possible paths of carrier transport in TRPL}\]

In the EL measurement, the carrier concentration is in the order of $10^{19}$ cm$^{-3}$ in InGaN QWs under the current density of 200 A/cm$^2$. The microsecond-width current pulse means that the carriers in the QWs are in quasi-equilibrium states on the bottom of CB. Some injected carriers are free and other are localized on the CB bottom in QWs, similar to the condition as free carrier relaxed and occupied at the localized states in TRPL. Because the strong BGR in InGaN QWs for large size μLEDs, the carriers transition from free states to localized ones is hindered, and more free carriers are confined in the QWs. The hot carriers may be appeared when the relaxation becomes some difficult. The luminous efficiency will be decreased and the spectral width will be broadened under the level of hundreds of A/cm$^2$. Under the same current density, the smaller size μLEDs are less affected by BGR effect because the compressive strain is relaxed. So the less BGR and uniform current distribution lead to the higher endured current density.

In the APSYS simulation, continuous current was injected, which is similar to the actual application situation. Under the injection level of kA/cm$^2$, the carrier concentration is about $10^{20}$ cm$^{-3}$ somewhere in the QWs in μLEDs, and the junction temperature is calculated above 450 K. Although the nonradiative losses and/or electron leakage are supposed heavily under this injection by now, the small size μLEDs can still work well. So they are not fatal under extremely high injection level. The effects of etching damage of small size μLEDs have been also estimated. The proportion of current affected by etching damage is very few. The less BGR effects due to the uniform current spreading and strain relaxation may lead to the excellent performance for small size μLEDs. Further reducing the size to nanometer, the nano LEDs will show strain free when the diameter reaches to 140 nm [29], the BGR effect will be decreased more. However, the effects of thermal dissipation and space charge limiting will prevent the improvement of the high injection level performance of nano LED [30]. So the μLEDs can be served as one of the most potential candidates for kA/cm$^2$ order current driven devices in the future.

4. Conclusions

In summary, the GaN-based μLEDs with different size are fabricated, and the
electroluminescence (EL) measurements stimulated by pulse current are performed on the different size µLEDs. It is found that tens micron µLEDs can work well under kA/cm² current density. Current distributions along the mesa of µLEDs are obtained with the simulations by the APSYS software package. The current spreading of several tens µLEDs are almost uniform. But due to the difference of recombination mechanism under high injection level, the maximum endured current density of the µLEDs of tens micron are quite different. TRPL measurements show that under high injection level, the smaller size µLEDs have a faster recombination rate in all wavelength range because of less BGR effect. Therefore, the less BGR effects may lead to the excellent performance for small size µLEDs, which are due to the uniform current spreading and strain relaxation.

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